- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

These devices contain four independent 2-input NOR buffer gates.

The SN5428, and SN54LS28 are characterized for operation over the full military temperature range of 55°C to 125°C. The SN7428, and SN74LS28 are characterized for operation from 0°C to 70°C.

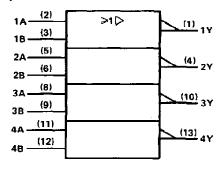
FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
A	В	Y
н	Х	٦
х	н	L
L	L	н

positive logic

$$Y = \overline{A + B}$$
 or $Y = \overline{A \cdot B}$

logic symbol f



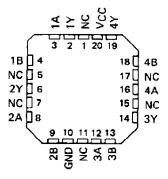
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5428, SN54LS28...J OR W PACKAGE SN7428...N PACKAGE SN74LS28...D OR N PACKAGE (TOP VIEW)

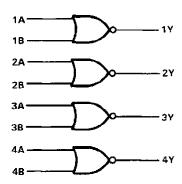
1Y 🗗	U14□ VCC
1A 🗖 2	13 4Y
1B □3	12 4B
2Y 🛚 4	11 🗀 4A
2A □5	10 🗀 3Y
2В 🗖 ก	9 🔁 3B
GND 7	8 3A

SN54LS28 . . . FK PACKAGE (TOP VIEW)

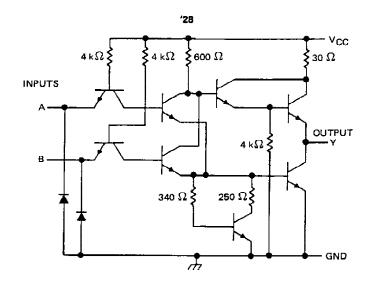


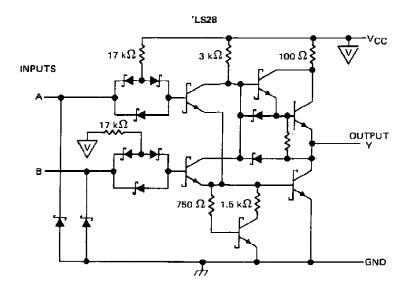
NC - No internal connection

logic diagram



schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage: '28	5.5 V
'LS28	
Operating free-air temperature: SN54'	–55°C to 1 25 °C
SN74′	
Storage temperature range	–65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal,



recommended operating conditions

		SN5428			SN7428		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	>
VIH High-level input voltage	2			2			٧
VIL Low-level input voltage			0.8			8.0	\ \
IOH High-level output current			2.4			- 2,4	mΑ
OL Low-level output current			48			48	mΑ
TA Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS †	MIN	TYP ‡	MAX	UNIT
۷ıĸ	VCC = MIN,	ij = - 12mA				- 1.5	٧
voн .	VCC = MIN,	V _{1L} = 0.8 V,	IQH = - 2.4 mA	2.4	3.4		٧
V _{OL}	VCC = MIN,	V _{IH} = 2 V,	I _{OL} = 48 mA		0.2	0.4	V
l _l	V _{CC} = MAX,	V ₁ = 5.5 V				1	mA
Ч н	V _{CC} = MAX,	V ₁ = 2.4 V				40	μΑ
IΙL	V _{CC} = MAX,	V ₁ = 0.4 V				-1.6	mA
IOS §	V _{CC} ≈ MAX			- 70		- 180	mA
Iссн	V _{CC} = MAX,	V _I = 0 V			12	21	mΑ
ICCL	V _{CC} = MAX,	See Note 2			33	57	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 3)

PARAMETER	FROM (INPUT)	TO (QUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
^t PLH			$R_L = 133 \Omega$,	C ₁ = 50 pF		6	9	ns
^t PH∟				CL 00 pi		8	12	ns
tPLH	A or B	Y		0- 150 - F		10	15	ns
^T PHL			$R_L = 133 \Omega$,	CL = 150 pF		12	18	п ร

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

^{\$} Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second. NOTE 2: One input at 4.5 V, all others at GND.

SN54LS28, SN74LS28 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS

recommended operating conditions

		SN54LS	28	SN74LS28			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC} Supply voltage	4.5	5	5,5	4.75	5	5.25	٧
VIH High-level input voltage	2			2		•	٧
VIL Low-level input voltage			0.7			8.0	V
IOH High-level output current			- 1.2			- 1,2	mA
IOL Low-level output current			12			24	mA
TA Operating free-air temperature	– 55		125	0		70	°¢

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †	SN54LS28	SN74LS28	110117
	TEST CONDITIONS I	MIN TYP# MAX	MIN TYP\$ MAX	UNIT
Vικ	V _{CC} = MIN, I _I = - 18 mA	- 1.5	- 1,5	٧
v _{он}	V _{CC} = MIN, V _{IL} = MAX, I _{OH} = -1.2 mA	2.5 3.4	2.7 3.4	V
V -	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 12 mA	0.25 0.4	0.24 0.4	v
VOL	V _{CC} = MIN, V _{IH} = 2 V, I _{OL} = 24 mA		0.35 0.5	
t _i	V _{CC} = MAX, V _I = 7 V	0.1	0.1	mA
^I IН	V _{CC} = MAX, V _I = 2.7 V	20	20	μА
IIL	V _{CC} = MAX, V ₁ = 0.4 V	- 0.4	- 0.4	mΑ
I _{OS} §	V _{CC} = MAX	- 30 - 130	- 30 - 130	mA
І ссн	V _{CC} = MAX, V _I = 0 V	1.8 3.6	1.8 3.6	mΑ
ICCL	VCC = MAX, See Note 2	6.9 13.8	6.9 13.8	mΑ

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN TYP	MAX	UNIT
tpLH	A or B	Y	R _L =667 Ω, C _L =45 pF	12	24	ns
^t PHL			11 00, 12, OC 49 pl	12	24	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time and the duration of the short circuit should not exceed one second, NOTE 2: One input at 4.5 V, all others at GND.

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